

(3,81 mm) .150"

DUAL LEAF 20 A POWER SOCKET

SPECIFICATIONS

For complete specifications see www.samtec.com?UPS

Insulator Material: Black LCF Contact Material: BeCu Plating: Sn or Au over 50μ"

(1,27 µm) Ni

Operating Temp Range:
-55°C to +105°C with Tin;
-55°C to +125°C with Gold

Voltage Rating: 375 VAC/530 VDC RoHS Compliant: Yes

Lead-Free Solderable: Yes

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



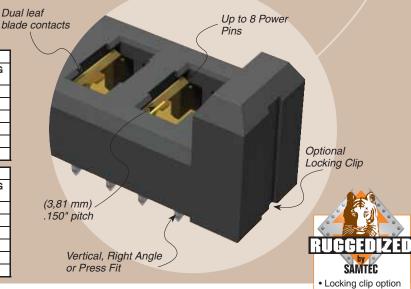
Mates with: **UPT**

UPT-V/UPS-V	
PINS	CURRENT RATING (PER CONTACT)
1	23 A
2	18.6 A
3	17.5 A
4	16.7 A
ALL	14 A
-L PLATING	

UPT-RA/UPS-RA	
PINS	CURRENT RATING (PER CONTACT)
1	23.5 A
2	20.1 A
3	16.9 A
4	15.5 A
ALL	13.3 A
-L PLATING	

POWER

PINS



ALSO AVAILABLE

(MOQ Required)

· Solder leads for (2,36 mm) .093" thick board

Contact Samtec.

TOOLING

Press fit tooling available. Contact Samtec.

MATED HEIGHT*	
UPS LEAD STYLE	UPT LEAD STYLE
	-03.0
-04.0	(7,00) .276
-07.0	(10,00) .394

*Processing conditions will affect mated height.

Note: Some sizes, styles and options are non-standard, non-returnable.

·02. -04.

UPS

-06, -08

LEAD STYLE В (3,75)(6,75) -04.0 .266 (6,75)07.0

-01 = RA only

LEAD

STYLE

-04.0 = (04,0 mm) .157" (–V & –PV only)

-07.0 = (07,0 mm) .276" (–V & –PV only)

TAIL LENGTH

-01 = Use with (1,60 mm) .062 Thick PCB (-V & -RA only)

-03= Use with (1,60 mm) .062th Thick PCB (-PV only)

PLATING OPTION

= 10µ" (0,25 µm) Gold on

contact.

Matte Tin

on tail

= Matte Tin (-RA option only)

Vertical (Not available with -T plating)

TAIL

–RA = Right Angle

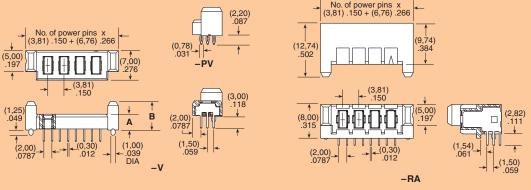
-PV = Press Vertical

-LC = Locking Clip (Manual placement required) Not available with -PV

option

OTHER

OPTION



Due to technical progress, all designs, specifications and components are subject to change without notice.